

Customer No. 20,995

1AP20 Rec'd AIRPORT 05 JAN 2006

Applicant : Hada et al.  
App. No : Unknown  
Filed : Herewith  
For : RESIST COMPOSITION, LAMINATE,  
AND METHOD FOR FORMING  
RESIST PATTERN  
Examiner : Unknown  
Art Unit : Unknown

ALL REFERENCES CONSIDERED EXCEPT WHERE LINED THROUGH. /JSC/

<b>INFORMATION DISCLOSURE STATEMENT BY APPLICANT</b>  (Multiple sheets used when necessary)	Application No.	Unknown
	Filing Date	Herewith
	First Named Inventor	Hada, Hideo
	Art Unit	Unknown
	Examiner	Unknown
SHEET 1 OF 1	Attorney Docket No.	SHIGA7.038APC

U.S. PATENT DOCUMENTS					
Examiner Initials	Cite No.	Document Number Number - Kind Code (if known) Example: 1,234,567 B1	Publication Date MM-DD-YYYY	Name of Patentee or Applicant	Pages, Columns, Lines Where Relevant Passages or Relevant Figures Appear

FOREIGN PATENT DOCUMENTS						
Examiner Initials	Cite No.	Foreign Patent Document Country Code-Number-Kind Code Example: JP 1234567 A1	Publication Date MM-DD-YYYY	Name of Patentee or Applicant	Pages, Columns, Lines Where Relevant Passages or Relevant Figures Appear	T <sup>1</sup>
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/JSC/	14	JP 2003-142381	05-16-2003	Tokyo Ohka Kogyo Co.		X

NON PATENT LITERATURE DOCUMENTS			
Examiner Initials	Cite No.	Include name of the author (in CAPITAL LETTERS), title of the article (when appropriate), title of the item (book, magazine, journal, serial, symposium, catalog, etc.), date, page(s), volume-issue number(s), publisher, city and/or country where published.	T <sup>1</sup>

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Examiner Signature	/John Chu/	Date Considered	02/01/2008
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\*Examiner: Initial if reference considered, whether or not citation is in conformance with MPEP 609. Draw line through citation if not in conformance and not considered. Include copy of this form with next communication to applicant.

T<sup>1</sup> - Place a check mark in this area when an English language Translation is attached.